

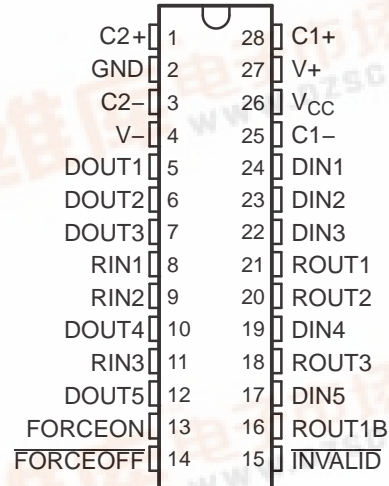
## FEATURES

- RS-232 Bus-Pin ESD Protection Exceeds ±15 kV Using Human-Body Model (HBM)
- Meet or Exceed the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operate With 3-V to 5.5-V  $V_{CC}$  Supply
- Operate up to 1000 kbit/s
- Five Drivers and Three Receivers
- Auto-Powerdown Plus Feature Enables Flexible Power-Down Mode
- Low Standby Current . . . 1  $\mu$ A Typical
- External Capacitors . . .  $4 \times 0.1 \mu$ F
- Accept 5-V Logic Input With 3.3-V Supply
- Always-Active Noninverting Receiver Output (ROUT1B)
- ESD Protection for RS-232 Interface Pins
  - ±15 kV – Human-Body Model (HBM)
  - ±8 kV – IEC61000-4-2, Contact Discharge
  - ±15 kV – IEC61000-4-2, Air-Gap Discharge

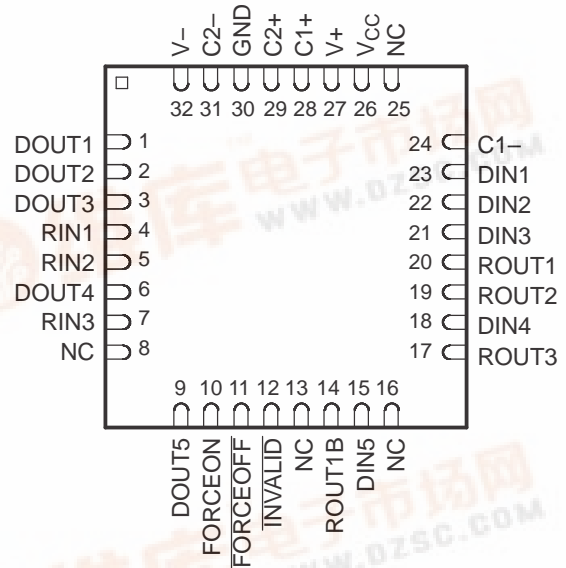
## APPLICATIONS

- Battery-Powered Systems
- PDAs
- Notebooks
- Subnotebooks
- Laptops
- Palmtop PCs
- Hand-Held Equipment
- Modems
- Printers

DB, DW, OR PW PACKAGE  
(TOP VIEW)



RHB PACKAGE  
(TOP VIEW)



## DESCRIPTION/ORDERING INFORMATION

The SN65C3238E and SN75C3238E consist of five line drivers, three line receivers, and a dual charge-pump circuit with ±15-kV ESD (HBM) protection on the driver output (DOUT) and receiver input (RIN) terminals. The devices meet the requirements of TIA/EIA-232-F and provide the electrical interface between notebook and subnotebook computer applications. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. In addition, the devices include an always-active noninverting output (ROUT1B), which allows applications using the ring indicator to transmit data while the device is powered down. These devices operate at data signaling rates up to 1000 kbit/s.

PRODUCT PREVIEW

**SN65C3238E, SN75C3238E**  
**3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVERS/RECEIVERS**  
**WITH ±15-kV ESD (HBM) PROTECTION**



SLLS726–MAY 2006

**DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

Flexible control options for power management are featured when the serial port and driver inputs are inactive. The auto-powerdown plus feature functions when FORCEON is low and FORCEOFF is high. During this mode of operation, if the devices do not sense valid signal transitions on all receiver and driver inputs for approximately 30 s, the built-in charge pump and drivers are powered down, reducing the supply current to 1 μA. By disconnecting the serial port or placing the peripheral drivers off, auto-powerdown plus occurs if there is no activity in the logic levels for the driver inputs. Auto-powerdown plus can be disabled when FORCEON and FORCEOFF are high. With auto-powerdown plus enabled, the devices activate automatically when a valid signal is applied to any receiver or driver input. INVALID is high (valid data) if any receiver input voltage is greater than 2.7 V or less than –2.7 V, or has been between –0.3 V and 0.3 V for less than 30 μs. INVALID is low (invalid data) if all receiver input voltages are between –0.3 V and 0.3 V for more than 30 μs. Refer to Figure 5 for receiver input levels.

**ORDERING INFORMATION**

| T <sub>A</sub> | PACKAGE <sup>(1)</sup> |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------------------|--------------|-----------------------|------------------|
| 0°C to 70°C    | SSOP – DB              | Tube of 50   | SN75C3238EDB          | 75C3238E         |
|                |                        | Reel of 2000 | SN75C3238EDBR         |                  |
|                | TSSOP – PW             | Tube of 50   | SN75C3238EPW          | Preview          |
|                |                        | Reel of 2000 | SN75C3238EPWR         |                  |
|                | SOIC – DW              | Tube of 50   | SN75C3238EDW          | 75C3238E         |
|                |                        | Reel of 2000 | SN75C3238EDWR         |                  |
|                | QFN – RHB              | Reel of 2000 | SN75C3238ECRHBR       | Preview          |
|                | –40°C to 85°C          | SSOP – DB    | Tube of 50            | SN65C3238EDB     |
| Reel of 2000   |                        |              | SN65C3238EDBR         |                  |
| TSSOP – PW     |                        | Tube of 50   | SN65C3238EPW          | Preview          |
|                |                        | Reel of 2000 | SN65C3238EPWR         |                  |
| SOIC – DW      |                        | Tube of 50   | SN65C3238EDW          | 65C3238E         |
|                |                        | Reel of 2000 | SN65C3238EDWR         |                  |
| QFN – RHB      |                        | Reel of 2000 | SN65C3238EIRHBR       | Preview          |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

PRODUCT PREVIEW

**FUNCTION TABLES**

**Each Driver<sup>(1)</sup>**

| INPUTS |         |          |   | OUTPUT DOUT | DRIVER STATUS                                      |
|--------|---------|----------|---|-------------|--|
| DIN    | FORCEON | FORCEOFF | TIME ELAPSED SINCE LAST RIN OR DIN TRANSITION |             |  |
| X      | X       | L        | X   | Z           | Powered off  |
| L      | H       | H        | X   | H           | Normal operation with auto-powerdown plus disabled |
| H      | H       | H        | X   | L           |  |
| L      | L       | H        | <30 s   | H           | Normal operation with auto-powerdown plus enabled  |
| H      | L       | H        | <30 s   | L           |  |
| L      | L       | H        | >30 s   | Z           | Powered off by auto-powerdown plus feature         |
| H      | L       | H        | >30 s   | Z           |  |

(1) H = high level, L = low level, X = irrelevant, Z = high impedance

**Each Receiver<sup>(1)</sup>**

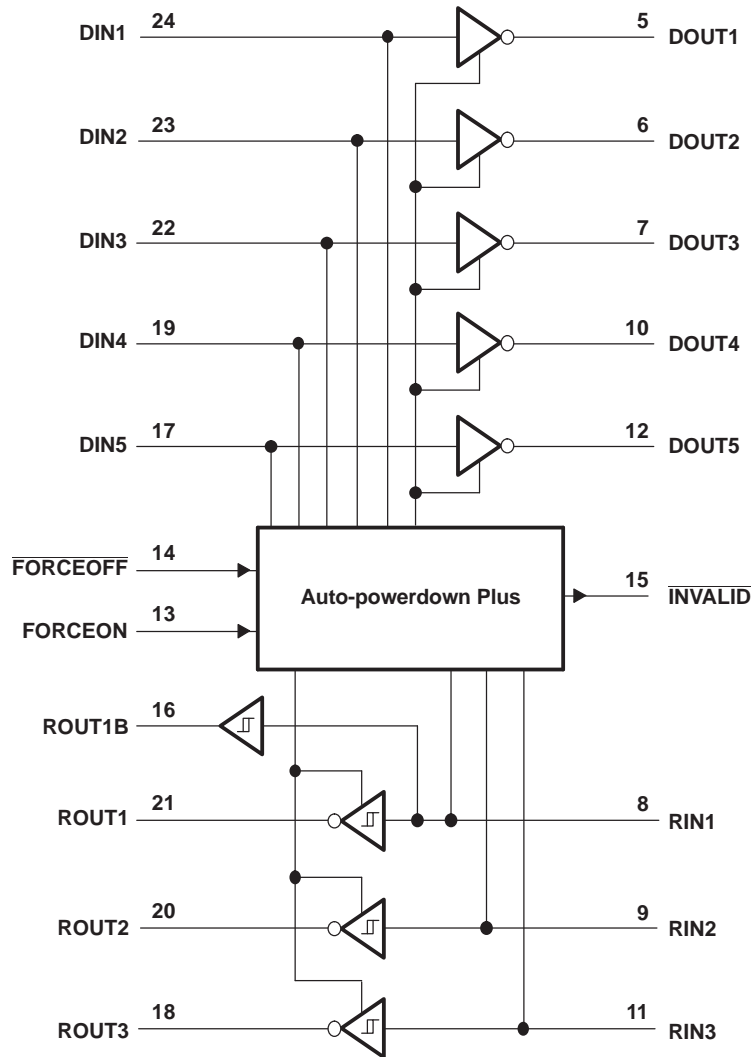
| INPUTS |           |          |   | OUTPUTS |                 | RECEIVER STATUS  |
|--------|-----------|----------|---|---------|-----------------|--|
| RIN1   | RIN2–RIN3 | FORCEOFF | TIME ELAPSED SINCE LAST RIN OR DIN TRANSITION | ROUT1B  | ROUT2 AND ROUT3 |  |
| L      | X         | L        | X   | L       | Z               | Powered off while ROUT1B is active                         |
| H      | X         | L        | X   | H       | Z               |  |
| L      | L         | H        | <30 s   | L       | H               | Normal operation with auto-powerdown plus disabled/enabled |
| L      | H         | H        | <30 s   | L       | L               |  |
| H      | L         | H        | <30 s   | H       | H               |  |
| H      | H         | H        | <30 s   | H       | L               |  |
| Open   | Open      | H        | <30 s   | L       | H               |  |

(1) H = high level, L = low level, X = irrelevant, Z = high impedance (off), Open = input disconnected or connected driver off

**SN65C3238E, SN75C3238E**  
**3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVERS/RECEIVERS**  
**WITH  $\pm 15$ -kV ESD (HBM) PROTECTION**

SLLS726–MAY 2006

**LOGIC DIAGRAM (POSITIVE LOGIC)**



**PRODUCT PREVIEW**

## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |   | MIN                        | MAX   | UNIT                  |      |
|------------------|---|----------------------------|-------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage range <sup>(2)</sup>                 | –0.3                       | 6     | V                     |      |
| V+               | Positive-output supply voltage range <sup>(2)</sup> | –0.3                       | 7     | V                     |      |
| V–               | Negative-output supply voltage range <sup>(2)</sup> | 0.3                        | –7    | V                     |      |
| V+ – V–          | Supply voltage difference <sup>(2)</sup>            |                            | 13    | V                     |      |
| V <sub>I</sub>   | Input voltage range                                 | Driver (FORCEOFF, FORCEON) | –0.3  | 6                     | V    |
|                  |   | Receiver                   | –25   | 25                    |      |
| V <sub>O</sub>   | Output voltage range                                | Driver                     | –13.2 | 13.2                  | V    |
|                  |   | Receiver (INVALID)         | –0.3  | V <sub>CC</sub> + 0.3 |      |
| $\theta_{JA}$    | Package thermal impedance <sup>(3)(4)</sup>         | DB package                 |       | 62                    | °C/W |
|                  |   | DW package                 |       | 46                    |      |
|                  |   | PW package                 |       | 62                    |      |
|                  |   | RHB package                |       | TBD                   |      |
| T <sub>J</sub>   | Operating virtual junction temperature              |                            | 150   | °C                    |      |
| T <sub>stg</sub> | Storage temperature range                           | –65                        | 150   | °C                    |      |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to network GND.
- (3) Maximum power dissipation is a function of T<sub>J(max)</sub>,  $\theta_{JA}$ , and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is P<sub>D</sub> = (T<sub>J(max)</sub> – T<sub>A</sub>)/ $\theta_{JA}$ . Operating at the absolute maximum T<sub>J</sub> of 150°C can affect reliability.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

## Recommended Operating Conditions<sup>(1)</sup>

See Figure 6

|                 |   | MIN                     | NOM                     | MAX | UNIT |   |
|-----------------|---|-------------------------|-------------------------|-----|------|---|
| Supply voltage  |   | V <sub>CC</sub> = 3.3 V | 3                       | 3.3 | 3.6  | V |
|                 |   | V <sub>CC</sub> = 5 V   | 4.5                     | 5   | 5.5  |   |
| V <sub>IH</sub> | Driver and control high-level input voltage | DIN, FORCEOFF, FORCEON  | V <sub>CC</sub> = 3.3 V | 2   | 5.5  | V |
|                 |   |                         | V <sub>CC</sub> = 5 V   | 2.4 | 5.5  |   |
| V <sub>IL</sub> | Driver and control low-level input voltage  | DIN, FORCEOFF, FORCEON  |                         | 0   | 0.8  | V |
| V <sub>I</sub>  | Receiver input voltage                      |                         |                         | –25 | 25   | V |
| T <sub>A</sub>  | Operating free-air temperature              | SN75C3238E              | 0                       | 70  | °C   |   |
|                 |   | SN65C3238E              | –40                     | 85  |      |   |

- (1) Testing supply conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F and C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V  $\pm$  0.5 V.

## Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 6)

| PARAMETER       |   | TEST CONDITIONS              | MIN   | TYP <sup>(2)</sup> | MAX     | UNIT    |
|-----------------|---|------------------------------|---|--------------------|---------|---------|
| I <sub>I</sub>  | Input leakage current                     | FORCEOFF, FORCEON            |   | $\pm 0.01$         | $\pm 1$ | $\mu$ A |
| I <sub>CC</sub> | Supply current<br>(T <sub>A</sub> = 25°C) | Auto-powerdown plus disabled | No load,<br>FORCEOFF and FORCEON at V <sub>CC</sub>                                       | 0.5                | 2       | mA      |
|                 |   | Powered off                  | No load, FORCEOFF at GND  | 1                  | 10      | $\mu$ A |
|                 |   | Auto-powerdown plus enabled  | No load, FORCEOFF at V <sub>CC</sub> ,<br>FORCEON at GND,<br>All RIN are open or grounded | 1                  | 10      |         |

- (1) Testing supply conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F and C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V  $\pm$  0.5 V.
- (2) All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

**SN65C3238E, SN75C3238E**  
**3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVERS/RECEIVERS**  
**WITH ±15-kV ESD (HBM) PROTECTION**



SLLS726–MAY 2006

**DRIVER SECTION**

**Electrical Characteristics<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 6](#))

| PARAMETER   | TEST CONDITIONS   | MIN  | TYP <sup>(2)</sup> | MAX  | UNIT |
|---|---|--|--------------------|------|------|
| V <sub>OH</sub> High-level output voltage                   | All DOUT at R <sub>L</sub> = 3 kΩ to GND                  | 5  | 5.4                |      | V    |
| V <sub>OL</sub> Low-level output voltage                    | All DOUT at R <sub>L</sub> = 3 kΩ to GND                  | –5   | –5.4               |      | V    |
| I <sub>IH</sub> High-level input current                    | V <sub>I</sub> = V <sub>CC</sub>                          |  | ±0.01              | ±1   | μA   |
| I <sub>IL</sub> Low-level input current                     | V <sub>I</sub> at GND                                     |  | ±0.01              | ±1   | μA   |
| I <sub>OS</sub> Short-circuit output current <sup>(3)</sup> | V <sub>CC</sub> = 3.6 V, V <sub>O</sub> = 0 V             |  | ±35                | ±60  | mA   |
|   | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0 V             |  | ±40                | ±100 |      |
| r <sub>o</sub> Output resistance                            | V <sub>CC</sub> , V+, and V– = 0 V, V <sub>O</sub> = ±2 V | 300  | 10M                |      | Ω    |
| I <sub>OZ</sub> Output leakage current                      | FORCEOFF = GND  | V <sub>O</sub> = ±12 V, V <sub>CC</sub> = 3 V to 3.6 V   |                    | ±25  | μA   |
|   |   | V <sub>O</sub> = ±10 V, V <sub>CC</sub> = 4.5 V to 5.5 V |                    | ±25  |      |

- (1) Testing supply conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.15 V; C1–C4 = 0.22 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047 μF and C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.
- (2) All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.
- (3) Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

**Switching Characteristics<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 6](#))

| PARAMETER   | TEST CONDITIONS   | MIN  | TYP <sup>(2)</sup> | MAX  | UNIT   |
|---|---|--|--------------------|------|--------|
| Maximum data rate (see <a href="#">Figure 1</a> )                   | R <sub>L</sub> = 3 kΩ, One DOUT switching   | C <sub>L</sub> = 1000 pF                                   |                    | 250  | kbit/s |
|   |   | C <sub>L</sub> = 250 pF, V <sub>CC</sub> = 3 V to 4.5 V    |                    | 1000 |        |
|   |   | C <sub>L</sub> = 1000 pF, V <sub>CC</sub> = 4.5 V to 5.5 V |                    | 1000 |        |
| t <sub>sk(p)</sub> Pulse skew <sup>(3)</sup>                        | C <sub>L</sub> = 150 pF to 2500 pF, R <sub>L</sub> = 3 kΩ to 7 kΩ, See <a href="#">Figure 2</a> |  | 25                 |      | ns     |
| SR(tr) Slew rate, transition region (see <a href="#">Figure 1</a> ) | C <sub>L</sub> = 150 pF to 1000 pF, R <sub>L</sub> = 3 kΩ to 7 kΩ, V <sub>CC</sub> = 3.3 V      |  | 18                 | 150  | V/μs   |

- (1) Testing supply conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.15 V; C1–C4 = 0.22 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047 μF and C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.
- (2) All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.
- (3) Pulse skew is defined as |t<sub>PLH</sub> – t<sub>PHL</sub>| of each channel of the same device.

**ESD Protection**

| PARAMETER | TEST CONDITIONS                  | TYP | UNIT |
|-----------|----------------------------------|-----|------|
| DOUT      | HBM                              | ±15 | kV   |
|           | IEC 61000-4-2, Air-Gap Discharge | ±15 |      |
|           | IEC 61000-4-2, Contact Discharge | ±8  |      |

PRODUCT PREVIEW

## RECEIVER SECTION

### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 6](#))

| PARAMETER |  | TEST CONDITIONS               | MIN            | TYP <sup>(2)</sup> | MAX      | UNIT       |
|-----------|--|-------------------------------|----------------|--------------------|----------|------------|
| $V_{OH}$  | High-level output voltage                | $I_{OH} = -1$ mA              | $V_{CC} - 0.6$ | $V_{CC} - 0.1$     |          | V          |
| $V_{OL}$  | Low-level output voltage                 | $I_{OL} = 1.6$ mA             |                |                    | 0.4      | V          |
| $V_{IT+}$ | Positive-going input threshold voltage   | $V_{CC} = 3.3$ V              |                | 1.5                | 2.4      | V          |
|           |  | $V_{CC} = 5$ V                |                | 1.8                | 2.4      |            |
| $V_{IT-}$ | Negative-going input threshold voltage   | $V_{CC} = 3.3$ V              | 0.6            | 1.2                |          | V          |
|           |  | $V_{CC} = 5$ V                | 0.8            | 1.5                |          |            |
| $V_{hys}$ | Input hysteresis ( $V_{IT+} - V_{IT-}$ ) |                               |                | 0.3                |          | V          |
| $I_{OZ}$  | Output leakage current (except ROUT1B)   | FORCEOFF = 0 V                |                | $\pm 0.05$         | $\pm 10$ | $\mu$ A    |
| $r_i$     | Input resistance                         | $V_i = \pm 3$ V to $\pm 25$ V | 3              | 5                  | 7        | k $\Omega$ |

(1) Testing supply conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm 0.15$  V; C1–C4 = 0.22  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm 0.3$  V; and C1 = 0.047  $\mu$ F and C2–C4 = 0.33  $\mu$ F at  $V_{CC} = 5$  V  $\pm 0.5$  V.

(2) All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^\circ$ C.

### Switching Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER   |   | TEST CONDITIONS   | TYP <sup>(2)</sup> | UNIT |
|-------------|---|---|--------------------|------|
| $t_{PLH}$   | Propagation delay time, low- to high-level output | $C_L = 150$ pF, See <a href="#">Figure 3</a>                        | 150                | ns   |
| $t_{PHL}$   | Propagation delay time, high- to low-level output | $C_L = 150$ pF, See <a href="#">Figure 3</a>                        | 150                | ns   |
| $t_{en}$    | Output enable time                                | $C_L = 150$ pF, $R_L = 3$ k $\Omega$ , See <a href="#">Figure 4</a> | 200                | ns   |
| $t_{dis}$   | Output disable time                               | $C_L = 150$ pF, $R_L = 3$ k $\Omega$ , See <a href="#">Figure 4</a> | 200                | ns   |
| $t_{sk(p)}$ | Pulse skew <sup>(3)</sup>                         | See <a href="#">Figure 3</a>  | 50                 | ns   |

(1) Testing supply conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm 0.15$  V; C1–C4 = 0.22  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm 0.3$  V; and C1 = 0.047  $\mu$ F and C2–C4 = 0.33  $\mu$ F at  $V_{CC} = 5$  V  $\pm 0.5$  V.

(2) All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^\circ$ C.

(3) Pulse skew is defined as  $|t_{PLH} - t_{PHL}|$  of each channel of the same device.

### ESD Protection

| PARAMETER | TEST CONDITIONS                  | TYP      | UNIT |
|-----------|----------------------------------|----------|------|
| RIN       | HBM                              | $\pm 15$ | kV   |
|           | IEC 61000-4-2, Air-Gap Discharge | $\pm 15$ |      |
|           | IEC 61000-4-2, Contact Discharge | $\pm 8$  |      |

**SN65C3238E, SN75C3238E**  
**3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVERS/RECEIVERS**  
**WITH  $\pm 15$ -kV ESD (HBM) PROTECTION**



SLLS726–MAY 2006

**AUTO-POWERDOWN PLUS SECTION**

**Electrical Characteristics**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5](#))

| PARAMETER        |   | TEST CONDITIONS  | MIN            | MAX | UNIT |
|------------------|---|--|----------------|-----|------|
| $V_{T+(valid)}$  | Receiver input threshold for <b>INVALID</b> high-level output voltage | FORCEON = GND, $\overline{FORCEOFF} = V_{CC}$                    |                | 2.7 | V    |
| $V_{T-(valid)}$  | Receiver input threshold for <b>INVALID</b> high-level output voltage | FORCEON = GND, $\overline{FORCEOFF} = V_{CC}$                    | -2.7           |     | V    |
| $V_{T(invalid)}$ | Receiver input threshold for <b>INVALID</b> low-level output voltage  | FORCEON = GND, $\overline{FORCEOFF} = V_{CC}$                    | -0.3           | 0.3 | V    |
| $V_{OH}$         | <b>INVALID</b> high-level output voltage                              | $I_{OH} = -1$ mA, FORCEON = GND, $\overline{FORCEOFF} = V_{CC}$  | $V_{CC} - 0.6$ |     | V    |
| $V_{OL}$         | <b>INVALID</b> low-level output voltage                               | $I_{OL} = 1.6$ mA, FORCEON = GND, $\overline{FORCEOFF} = V_{CC}$ |                | 0.4 | V    |

**Switching Characteristics**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5](#))

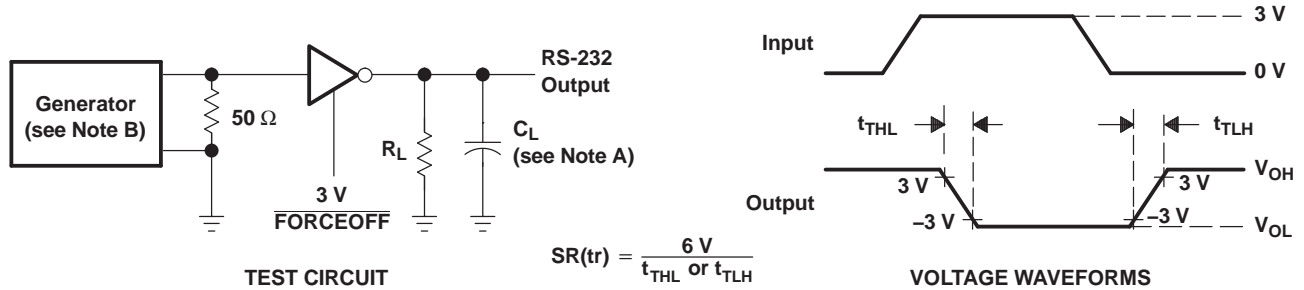
| PARAMETER     |   | MIN | TYP <sup>(1)</sup> | MAX | UNIT    |
|---------------|---|-----|--------------------|-----|---------|
| $t_{valid}$   | Propagation delay time, low- to high-level output |     | 0.1                |     | $\mu$ s |
| $t_{invalid}$ | Propagation delay time, high- to low-level output |     | 50                 |     | $\mu$ s |
| $t_{en}$      | Supply enable time                                |     | 25                 |     | $\mu$ s |
| $t_{dis}$     | Receiver or driver edge to auto-powerdown plus    | 15  | 30                 | 60  | s       |

(1) All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^\circ\text{C}$ .

PRODUCT PREVIEW

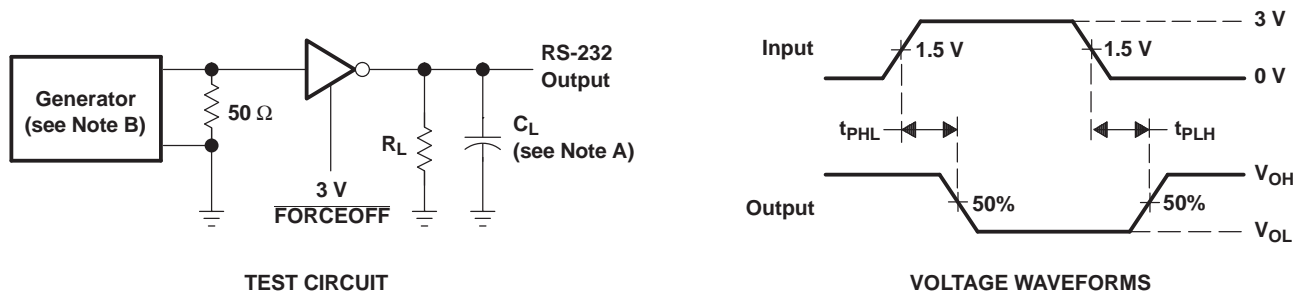


PARAMETER MEASUREMENT INFORMATION



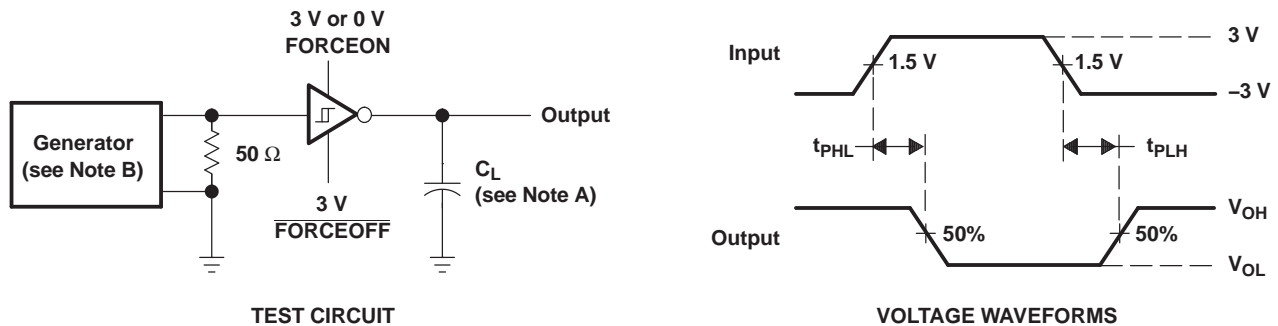
- A.  $C_L$  includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

Figure 1. Driver Slew Rate



- A.  $C_L$  includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

Figure 2. Driver Pulse Skew



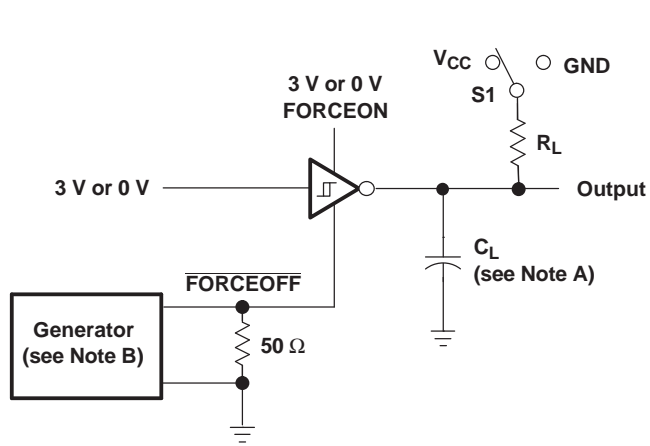
- A.  $C_L$  includes probe and jig capacitance.
- B. The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

Figure 3. Receiver Propagation Delay Times

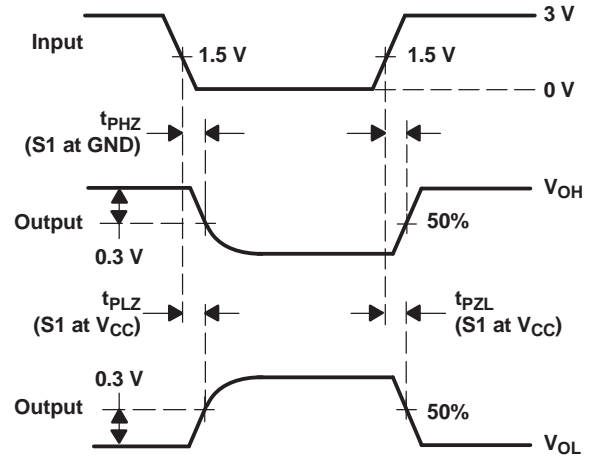
**SN65C3238E, SN75C3238E**  
**3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVERS/RECEIVERS**  
**WITH  $\pm 15$ -kV ESD (HBM) PROTECTION**

SLLS726–MAY 2006

**PARAMETER MEASUREMENT INFORMATION (continued)**



**TEST CIRCUIT**

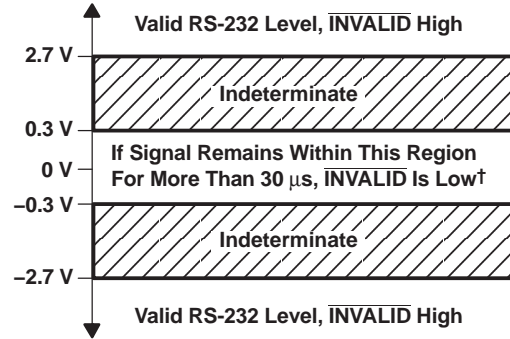
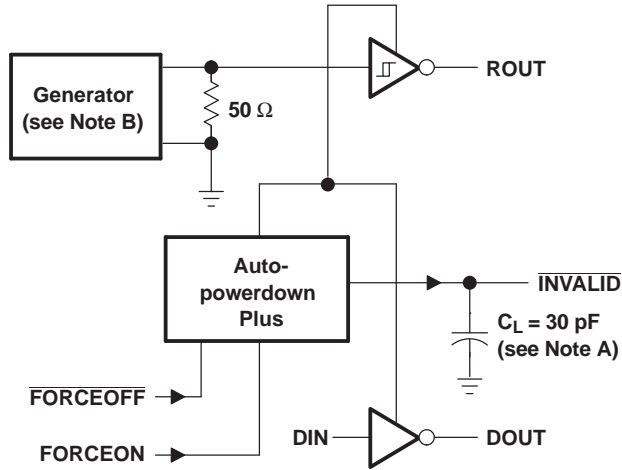


**VOLTAGE WAVEFORMS**

- A.  $C_L$  includes probe and jig capacitance.
- B. The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.
- C.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- D.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .

**Figure 4. Receiver Enable and Disable Times**

PARAMETER MEASUREMENT INFORMATION (continued)



† Auto-powerdown plus disables drivers and reduces supply current to 1  $\mu$ A.

TEST CIRCUIT

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. The pulse generator has the following characteristics: PRR = 5 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

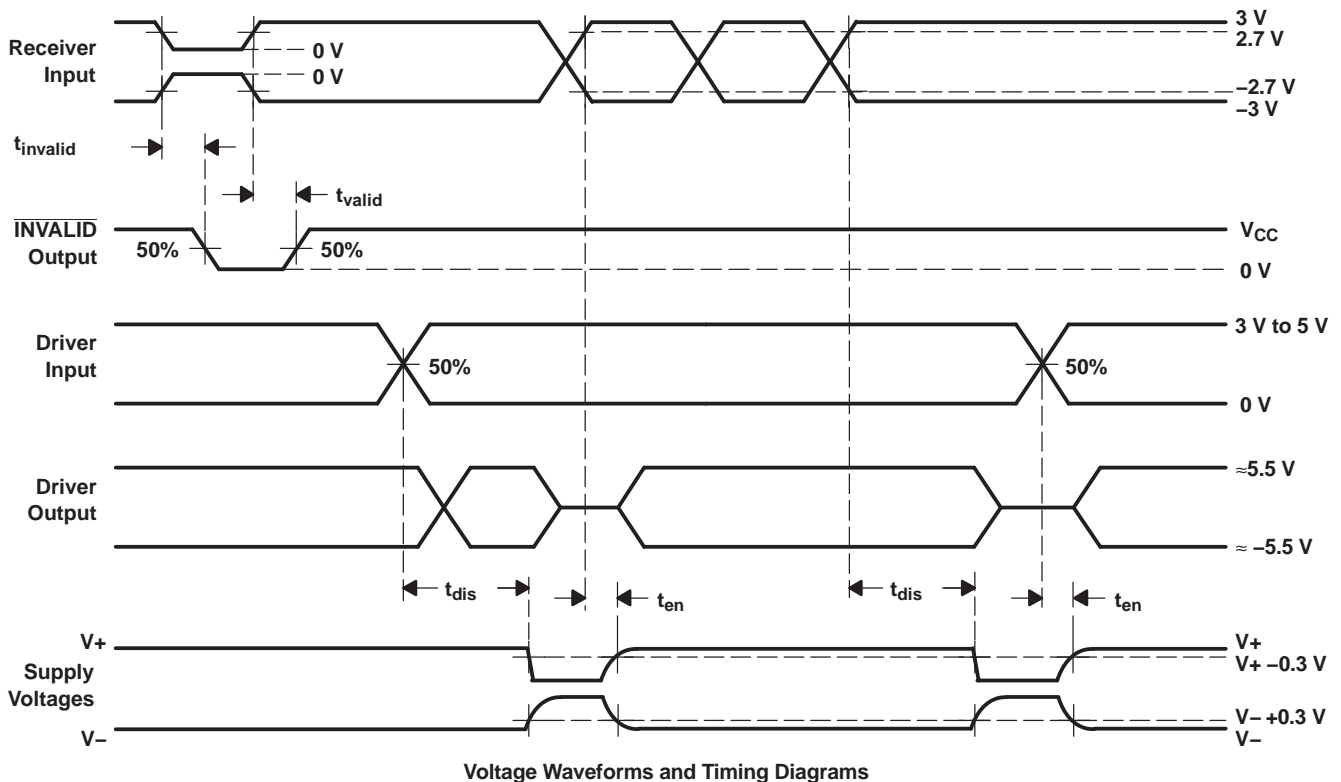
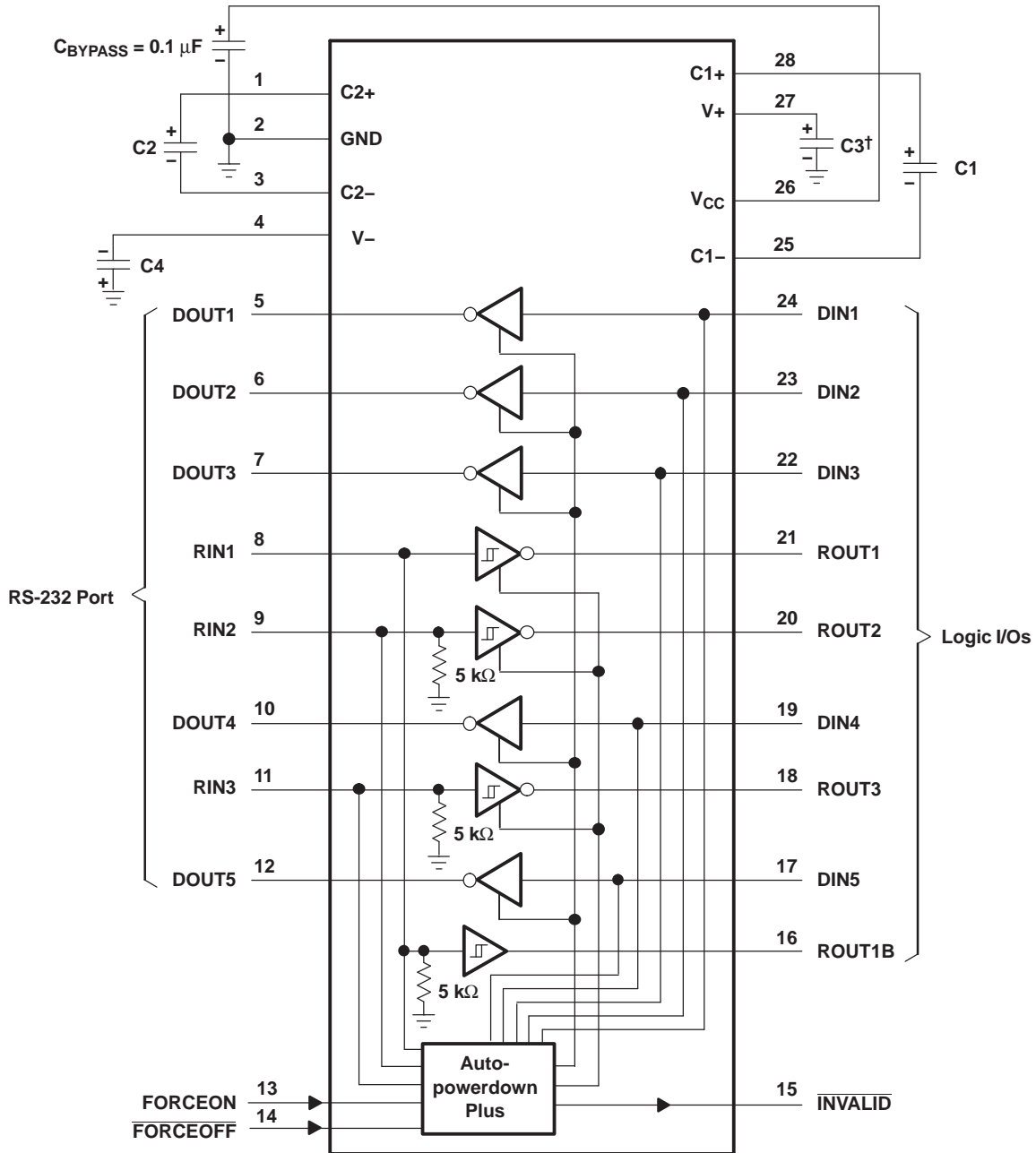


Figure 5.  $\overline{\text{INVALID}}$  Propagation-Delay Times and Supply-Enabling Time

**SN65C3238E, SN75C3238E**  
**3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVERS/RECEIVERS**  
**WITH ±15-kV ESD (HBM) PROTECTION**

SLLS726–MAY 2006

**APPLICATION INFORMATION**



**V<sub>CC</sub> vs CAPACITOR VALUES**

| V <sub>CC</sub> | C1       | C2, C3, and C4 |
|-----------------|----------|----------------|
| 3.3 V ± 0.15 V  | 0.1 μF   | 0.1 μF         |
| 3.3 V ± 0.3 V   | 0.22 μF  | 0.22 μF        |
| 5 V ± 0.5 V     | 0.047 μF | 0.33 μF        |
| 3 V to 5.5 V    | 0.22 μF  | 1 μF           |

† C3 can be connected to V<sub>CC</sub> or GND.

NOTES: A. Resistor values shown are nominal.

B. Nonpolarized ceramic capacitors are acceptable. If polarized tantalum or electrolytic capacitors are used, they should be connected as shown.

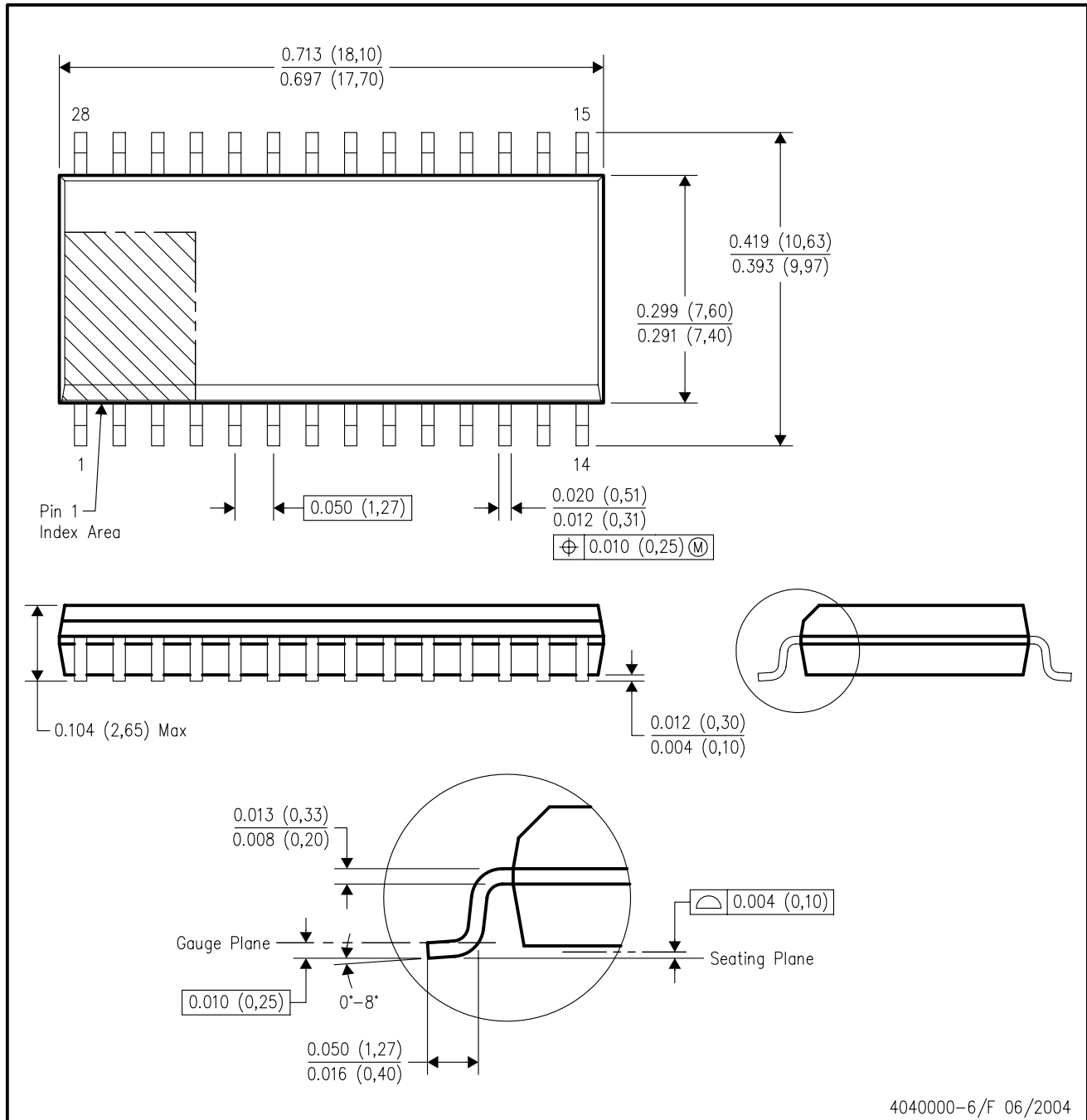
**Figure 6. Typical Operating Circuit and Capacitor Values**

**PRODUCT PREVIEW**

# MECHANICAL DATA

DW (R-PDSO-G28)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-013 variation AE.

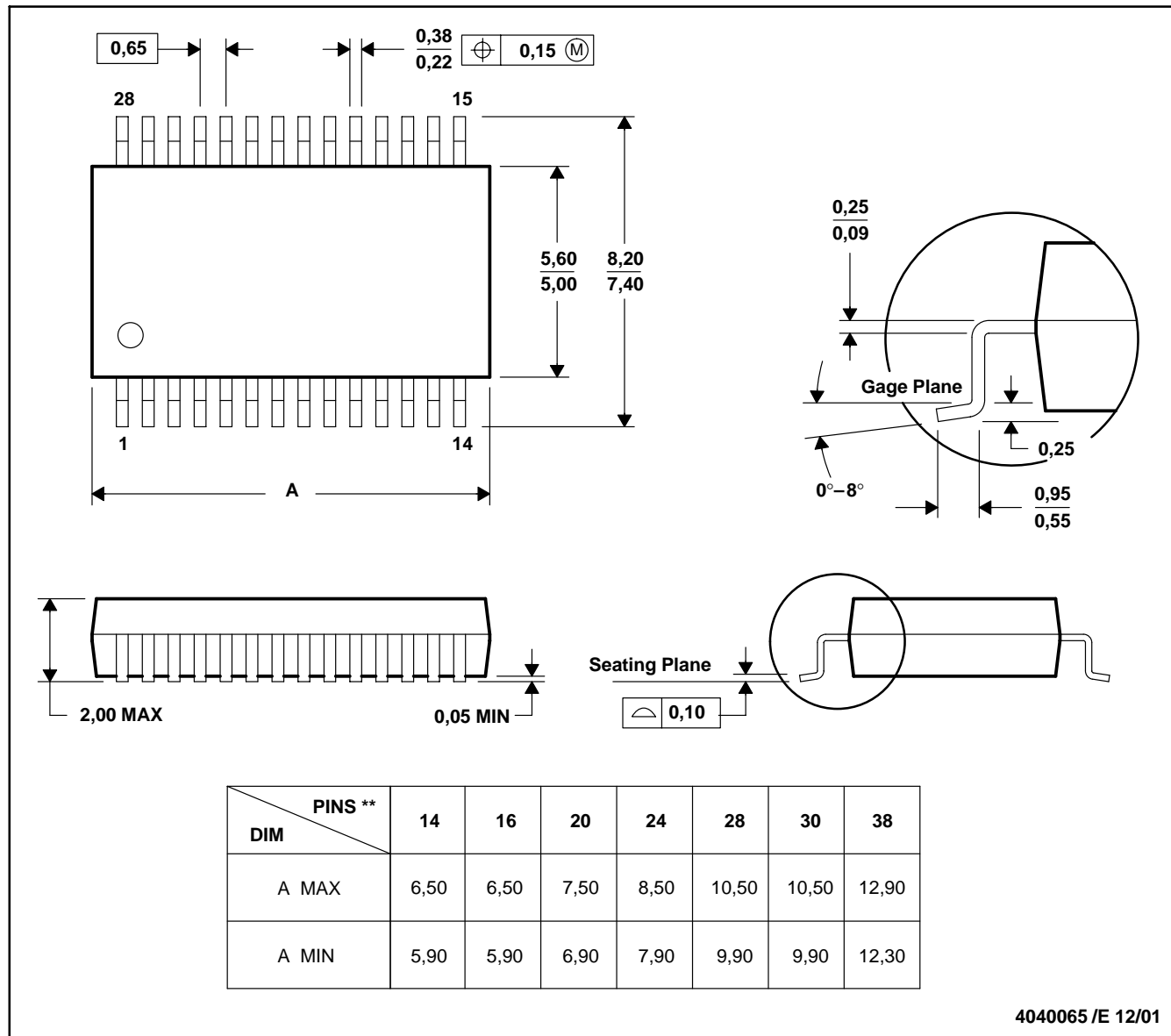
# MECHANICAL DATA

MSS0002E – JANUARY 1995 – REVISED DECEMBER 2001

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| <b>Products</b>  |  | <b>Applications</b> |  |
|------------------|--|---------------------|--|
| Amplifiers       | <a href="http://amplifier.ti.com">amplifier.ti.com</a>             | Audio               | <a href="http://www.ti.com/audio">www.ti.com/audio</a>                   |
| Data Converters  | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>     | Automotive          | <a href="http://www.ti.com/automotive">www.ti.com/automotive</a>         |
| DSP              | <a href="http://dsp.ti.com">dsp.ti.com</a>                         | Broadband           | <a href="http://www.ti.com/broadband">www.ti.com/broadband</a>           |
| Interface        | <a href="http://interface.ti.com">interface.ti.com</a>             | Digital Control     | <a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a> |
| Logic            | <a href="http://logic.ti.com">logic.ti.com</a>                     | Military            | <a href="http://www.ti.com/military">www.ti.com/military</a>             |
| Power Mgmt       | <a href="http://power.ti.com">power.ti.com</a>                     | Optical Networking  | <a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a> |
| Microcontrollers | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a> | Security            | <a href="http://www.ti.com/security">www.ti.com/security</a>             |
|                  |  | Telephony           | <a href="http://www.ti.com/telephony">www.ti.com/telephony</a>           |
|                  |  | Video & Imaging     | <a href="http://www.ti.com/video">www.ti.com/video</a>                   |
|                  |  | Wireless            | <a href="http://www.ti.com/wireless">www.ti.com/wireless</a>             |

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265